

STFI12N60M2

N-channel 600 V, 0.395 Ω typ., 9 A MDmesh™ M2 Power MOSFET in an I²PAKFP package

Datasheet - production data

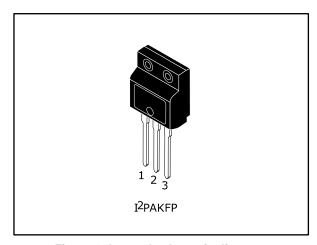
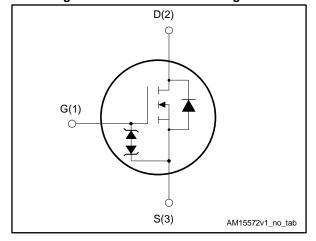


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} R _{DS(on)} max. | | I _D | Ртот |
|-------------|--|---------|----------------|------|
| STFI12N60M2 | 600 V | 0.450 Ω | 9 A | 25 W |

- Extremely low gate charge
- Excellent output capacitance (C_{OSS}) profile
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|-------------|---------|---------|---------|
| STFI12N60M2 | 12N60M2 | I²PAKFP | Tube |

May 2015 DocID027899 Rev 1 1/12

Contents STFI12N60M2

Contents

| 1 | Electric | al ratings | 3 |
|---|----------|---|----|
| 2 | Electric | al characteristics | 4 |
| | 2.1 | Electrical characteristics (curves) | 6 |
| 3 | Test cir | cuits | 8 |
| 4 | Packag | e information | 9 |
| | 4.1 | I ² PAKFP (TO-281) package information | 9 |
| 5 | Revisio | n history | 11 |



STFI12N60M2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|--|------------|-------|
| V_{GS} | Gate-source voltage | ±25 | V |
| I _D ⁽¹⁾ | Drain current (continuous) at T _{case} = 25 °C | 9 | Α |
| ID | Drain current (continuous) at T _{case} = 100 °C | 5.7 | A |
| I _{DM} ⁽²⁾ | Drain current (pulsed) | 36 | Α |
| P _{TOT} | Total dissipation at T _{case} = 25 °C | 25 | W |
| dv/dt ⁽³⁾ | Peak diode recovery voltage slope | 15 | V/ns |
| dv/dt ⁽⁴⁾ | MOSFET dv/dt ruggedness | 50 | V/IIS |
| V _{ISO} | Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T_C = 25 °C) | 2.5 | kV |
| T _{stg} | Storage temperature | FF to 150 | °C |
| T _j | Operating junction temperature | -55 to 150 | C |

Notes:

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|-----------------------|-------------------------------------|-------|-------|
| R _{thj-case} | Thermal resistance junction-case | 5 | 90044 |
| R _{thj-amb} | Thermal resistance junction-ambient | 62.5 | °C/W |

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|--------------------------------|---|-------|------|
| I _{AR} ⁽¹⁾ | Avalanche current, repetitive or not repetitive | 2.6 | Α |
| E _{AR} ⁽²⁾ | Single pulse avalanche energy | 117 | mJ |

Notes:

⁽¹⁾ Limited by maximum junction temperature.

 $^{^{\}left(2\right) }$ Pulse width is limited by safe operating area.

 $^{^{(3)}}$ $I_{SD} \leq 9$ A, di/dt=400 A/µs; $V_{DS(peak)} < V_{(BR)DSS}, \ V_{DD} = 80\% \ V_{(BR)DSS}.$

 $^{^{(4)}} V_{DS} \le 480 V.$

 $^{^{\}left(1\right)}$ Pulse width limited by $T_{jmax}.$

 $^{^{(2)}}$ starting T_j = 25 °C, I_D = $I_{AR},\,V_{DD}$ = 50 V.

Electrical characteristics STFI12N60M2

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 5: Static

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------------------------|--|------|-------|-------|------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$ | 600 | | | V |
| | Zoro goto voltago drain | $V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$ | | | 1 | |
| I _{DSS} | Zero gate voltage drain current | $V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{case} = 125 \text{ °C}$ | | | 100 | μΑ |
| I _{GSS} | Gate-body leakage current | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$ | | | ±10 | μΑ |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2 | 3 | 4 | V |
| R _{DS(on)} | Static drain-source on- resistance | $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ | | 0.395 | 0.450 | Ω |

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|------------------|-------------------------------|--|------|------|------|------|
| C _{iss} | Input capacitance | | ı | 538 | • | |
| Coss | Output capacitance | V _{DS} = 100 V, f = 1 MHz, | - | 29 | • | pF |
| C _{rss} | Reverse transfer capacitance | $V_{GS} = 0 V$ | ı | 1.1 | 1 | P. |
| Coss eq. (1) | Equivalent output capacitance | $V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V | 1 | 106 | 1 | pF |
| R_{G} | Intrinsic gate resistance | f = 1 MHz, I _D = 0 A | - | 7 | - | Ω |
| Q_g | Total gate charge | $V_{DD} = 400 \text{ V}, I_{D} = 9 \text{ A},$ | ı | 16 | • | |
| Q_gs | Gate-source charge | V _{GS} = 10 V (see <i>Figure 15</i> : | - | 2.3 | • | nC |
| Q_{gd} | Gate-drain charge | "Gate charge test circuit") | 1 | 8.5 | • | |

Notes:

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|---|------|------|------|------|
| t _{d(on)} | Turn-on delay time | $V_{DD} = 300 \text{ V}, I_D = 4.5 \text{ A}$ | - | 9.2 | - | |
| t _r | Rise time | $R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Switching times | - | 9.2 | - | |
| t _{d(off)} | Turn-off delay time | test circuit for resistive load" | ı | 56 | 1 | ns |
| t _f | Fall time | and Figure 19: "Switching time waveform") | - | 18 | - | |

 $^{^{(1)}}$ $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 8: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|-------------------------------|---|------|------|------|------|
| I _{SD} | Source-drain current | | - | | 9 | Α |
| I _{SDM} ⁽¹⁾ | Source-drain current (pulsed) | | - | | 36 | Α |
| $V_{SD}^{(2)}$ | Forward on voltage | $V_{GS} = 0 \text{ V}, I_{SD} = 9 \text{ A}$ | - | | 1.6 | V |
| t _{rr} | Reverse recovery time | $I_{SD} = 9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ | - | 284 | | ns |
| Q _{rr} | Reverse recovery charge | V _{DD} = 60 V (see Figure 16: "Test circuit for inductive | - | 2.4 | | μC |
| I _{RRM} | Reverse recovery current | load switching and diode recovery times") | - | 17 | | Α |
| t _{rr} | Reverse recovery time | $I_{SD} = 9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ | - | 404 | | ns |
| Q _{rr} | Reverse recovery charge | $V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C} \text{ (see}$ Figure 16: "Test circuit for | - | 3.5 | | μC |
| I _{RRM} | Reverse recovery current | inductive load switching and diode recovery times") | - | 17.5 | | Α |

Notes:

 $^{^{\}left(1\right) }$ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

2.1 Electrical characteristics (curves)

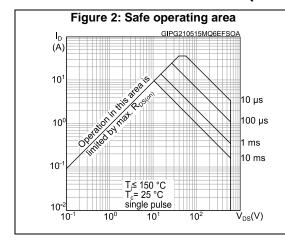
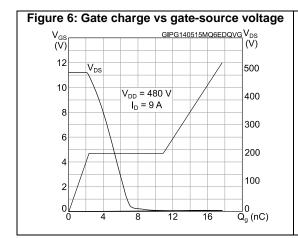
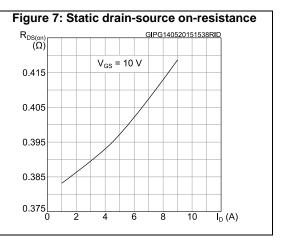


Figure 3: Thermal impedance $K = \frac{10^{-1}}{\delta = 0.5}$ $\frac{\delta = 0.2}{\delta = 0.1}$ $\frac{\delta = 0.05}{\delta = 0.02}$ $\frac{\delta = 0.02}{\delta = 0.01}$ $\frac{\delta = 0.02}{\delta = 0.01}$ $\frac{\delta = 0.02}{\delta = 0.01}$ $\frac{\zeta_{th} = K^* R_{th}, c}{\delta = t_p T}$ $\frac{\zeta_{th} = K^* R_{th}, c}{\delta = t_p T}$ $\frac{\zeta_{th} = K^* R_{th}, c}{\delta = t_p T}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$ $\frac{10^{-3}}{10^{-4}}$





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STFI12N60M2 Electrical characteristics

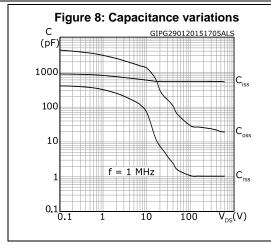


Figure 9: Normalized gate threshold voltage vs temperature

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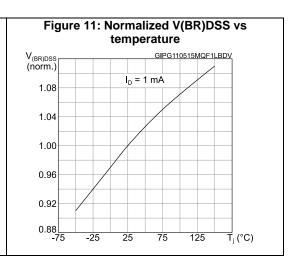
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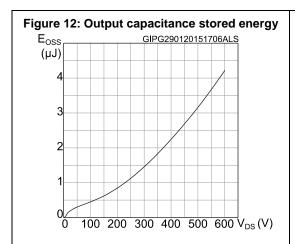
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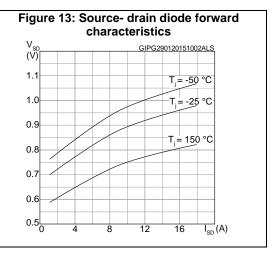
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Figure 10: Normalized on-resistance vs temperature R_{DS(on)} (norm.) GIPG110515MQF1LRON V_{GS} = 10 V 2.2 1.8 1.4 1.0 0.6 0.2L -75 -25 25 75 125 T_i (°C)



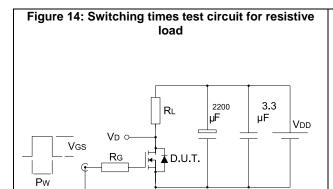


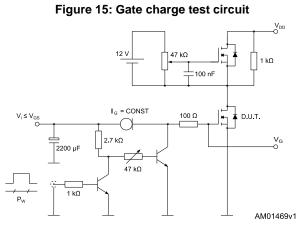


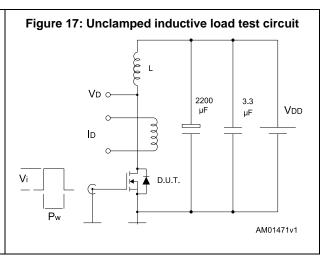
Test circuits STFI12N60M2

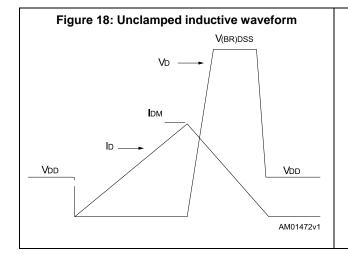
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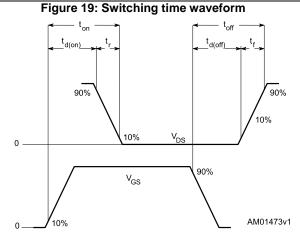
3 Test circuits











8/12 DocID027899 Rev 1

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STFI12N60M2 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 I²PAKFP (TO-281) package information

Α Н В D1 97 11 D -F1 (x3) F(x3)G 8291506 Re v. C

Figure 20: I²PAKFP (TO-281) package outline

577

Table 9: I²PAKFP (TO-281) mechanical data

| Dim | , | mm | |
|------|-------|------|-------|
| Dim. | Min. | Тур. | Max. |
| A | 4.40 | - | 4.60 |
| В | 2.50 | | 2.70 |
| D | 2.50 | | 2.75 |
| D1 | 0.65 | | 0.85 |
| Е | 0.45 | | 0.70 |
| F | 0.75 | | 1.00 |
| F1 | | | 1.20 |
| G | 4.95 | | 5.20 |
| Н | 10.00 | | 10.40 |
| L1 | 21.00 | | 23.00 |
| L2 | 13.20 | | 14.10 |
| L3 | 10.55 | | 10.85 |
| L4 | 2.70 | | 3.20 |
| L5 | 0.85 | | 1.25 |
| L6 | 7.50 | 7.60 | 7.70 |

STFI12N60M2 Revision history

5 Revision history

Table 10: Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 22-May-2015 | 1 | First release. |

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